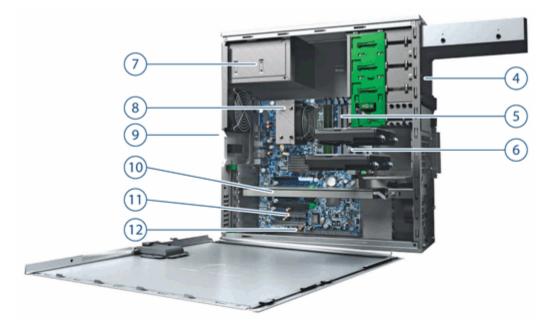
Overview

HP recommends Windows Vista® Business



- 1. 3 External 5.25" Bays
- 2. Power Button
- 3. Front I/O: 2 USB 2.0, 1 IEEE 1394a (optional card required), Headphone, Microphone





Overview

- 4. 3 External 5.25" Bays
- 5. 4 DIMM Slots for DDR3 ECC Memory
- 6. 2 Internal 3.5" Bays
- 7. 475W, 85% efficient Power Supply
- 8. Dual/Quad Core Intel 3500 Series Processors
- Rear I/O: 6 USB 2.0, PS/2 keyboard/mouse
 1 RJ-45 to Integrated Gigabit LAN
 1 Audio Line In, 1 Audio Line Out, 1 Microphone In
- 10. 2 PCIe x16 Gen2 Slots
- 11.. 1 PCIe x4 Gen2, 1 PCIe x4 Gen1, 2 PCI Slots
- 12 4 Internal USB 2.0 ports

Form Factor	Convertible Minitower
Compatible Operating	Genuine Windows Vista® Business 32-bit*
Systems	Genuine Windows Vista® Business 64-bit*
	Genuine Windows Vista® Business 32-bit with downgrade to Windows® XP Professional 32-bit
	custom installed** (expected available until August 2009)
	Genuine Windows Vista® Business 64-bit with downgrade to Windows® XP Professional x64
	custom installed** (expected available until August 2009)
	HP Linux Installer Kit for Linux (includes drivers for both 32-bit & 64-bit OS versions of Red Hat
	Enterprise Linux WS4 and WS5 - see: http://www.hp.com/workstations/software/linux)
	Novell Suse SLED 11 (expected availability May 2009)
	*Certain Windows Vista product features require advanced or additional hardware. See
	http://www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and
	http://www.microsoft.com/windowsvista/getready/rardwarereqs.mspx and http://www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista
	Upgrade Advisor can help you determine which features of Windows Vista will run on your
	computer. To download the tool, visit http://www.windowsvista.com/upgradeadvisor.
	**Windows Vista Business disk may also be included for future upgrade if desired. To qualify for
	this downgrade an end user must be a business (including governmental or educational
	institutions) and is expected to order at least 25 customer systems with the same custom image.
Available Processors	Intel® Xeon® Processor W3503 2.40 GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core
	Intel Xeon Processor W3505 2.53 GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core
	Intel Xeon Processor W3520 2.66 GHz, 8MB cache, 1066 memory, 4.8 GT/s QPI, Quad-Core, HT,
	Turbo
	Intel Xeon Processor W3540 2.93 GHz, 8MB cache, 1066 memory, 4.8 GT/s QPI, Quad-Core, HT,
	Turbo
	Intel Xeon Processor W3570 3.20 GHz, 8MB cache, 1333 memory, 6.4 GT/s QPI, Quad-Core, HT,
	Turbo
Available Processor	Intel processor numbers are not a measurement of higher performance. Processor numbers
Disclaimers	differentiate features within each processor family, not across different processor families. See:
	http://www.intel.com/products/processor_number/ for details.
	64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset,
	BIOS, operating system, device drivers and applications enabled for Intel 64 architecture.
	Processor will not operate (including 32-bit operation) without an Intel 64 architecture-enabled
	BIOS. Performance will vary depending on your hardware and software configurations. See:
	http://www.intel.com/info/em64t for more information.
	Dual-Core and Quad-Core technologies are designed to improve performance of multithreaded
	software products and hardware-aware multitasking operating systems and may require
	appropriate operating system software for full benefits; check with software provider to determine
	suitability; Not all customers or software applications will necessarily benefit from use of these
	technologies.
	Intel's numbering is not a measurement of higher performance.
Color	Jack Black/Alloy metallic
	Yes. 5.25" drives rotate for Minitower or Desktop orientation.
Convertibility	



Overview Expansion Slots (see 2 PCI slots (full-height, full-length) system board section for • 1 PCI Express Gen2 slot x8 mechanical/x4 electrical more details) • 1 PCI Express Gen1 slot x8 mechanical/x4 electrical 2 PCI Express x16 Gen2 slots (one dedicated for graphics) Expansion Bavs (see • 2 internal 3.5" bavs storage section for more • 3 external 5.25" bays details) NOTE: Third external 5.25" bay is not full depth; maximum depth 170 mm (6.7 inches) Front I/O 2 USB 2.0, 1 IEEE 1394 (requires optional PCI card to function), 1 audio out, and 1 microphone. 6 USB 2.0, 1 optional serial port, 2 PS/2, RJ-45 (NIC), 1 audio line in, 1 audio line out, 1 Rear I/O microphone in; audio ports can be retasked to function as line in, line out, microphone, or headphone. Interfaces Supported 22-in-1 Media Card Reader (optional) Chassis Dimensions Standard minitower orientation: 6.6 x 17.9 x 17.7 in (16.79 x 45.53 x 45.02 cm) $(W \times D \times H)$ Converted desktop orientation: 6.6 x 17.9 x 17.7 in (16.79 x 45.53 x 45.02 cm) Weight Exact weights depend upon configuration Minimum: 29.8 lbs (13.5 kg) Standard: 33.2 lbs (15.1 kg) Maximum: 43.2 lbs (19.6 kg) Temperature Operating: 40° to 95°F (5° to 35°C) Non-operating -40° to 140° F (-40° to 60° C) Humidity Operating: 8% to 85% Non-operating 8% to 90% Maximum Altitude (non Operating: 10,000 feet; 3,000 m pressurized) Non-operating 30,000 feet; 9,100 m

Power Supply 475 watts wide-ranging, active Power Factor Correction, 85% Efficient



Supported Components

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes	
Quad-Core Intel® Xeon® Processor 3500 Series with Intel® 64 Architecture						
	Intel Xeon W3503, 2.40GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core	Y	Ν			
	Intel Xeon W3505, 2.53GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core	Y	Ν			
	Intel Xeon W3520, 2.66GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo	Y	Ν			
	Intel Xeon W3540, 2.93GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo	Y	Ν			
	Intel Xeon W3570, 3.20GHz, 8MB cache, 1333 memory, 6.4GT/s, Quad-Core, HT, Turbo	Y	Ν			
	 When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. S http://www.intel.com/products/processor_number/ for details. Dual-Core and Quad-Core technologies are designed to improve performance of multithreade software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to detern suitability; Not all customers or software applications will necessarily benefit from use of the technologies. 					
	64-bit computing on Intel® 64 architecture requires a computer system with a processor, chip BIOS, operating system, device drivers and applications enabled for Intel 64 architecture. Processor will not operate (including 32-bit operation) without an Intel 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See:				bled	

Intel's numbering is not a measurement of higher performance.

http://www.intel.com/info/em64t for more information.

Sub-Section Description/Notes

For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 GB of system disk is reserved for system recovery software (Vista).

SAS Hard Drives

		Factory Configured	Option Kit	Kit Part Number	Support Notes
	HP SAS (Serial Attached SCSI) Hard Drives for HI	P Workstation	S		
	146 GB 15K rpm SAS 3.0 Gb/s 3.5" Hard Drive	Y	Y	EA330AA	
	300 GB 15K rpm SAS 3.0 Gb/s 3.5" Hard Drive	Y	Y	EM174AA	
	450 GB 15K rpm SAS 3.0 Gb/s 3.5" Hard Drive	Y	Y	FM803AA	
	Sub-Section Description/Notes				
	6.0 TB max x	[
	Removable Boot Drive option				
SATA Hard Drives	SATA (Serial ATA) Hard Drives for HP Workstation	ns			



Option

Supported Components

160 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Y	Y	PV944A
250GB SATA 7200 rpm 3Gb/s 3.5" HDD (for HP Z- Workstations)	Y	Y	PY278AA
320 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Y	Y	FH963AA
500 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Y	Y	PV943A
1 TB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Y	Y	GE262AA
160 GB 10K rpm SATA with NCQ 2.5" Hard Drive	Y	Y	EW222AA
300 GB 10K rpm SATA with NCQ 2.5" Hard Drive	Y	Y	FM802AA
NOTE: SAS Controller, not integrated, is required)			

For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 GB of system disk is reserved for system recovery software (Vista).

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated SATA 3.0 Gb/s Controller				
	Integrated SATA 3.0 Gb/s	Y	Ν		
	Factory integrated RAID on motherboard for	r SATA drives			
	RAID 0 Configuration - Striped Array	Y	Ν		See note 1
	RAID 0 Data Configuration Boot/OS Drive + 2 Drive Striped Array	Y	Ν		See note 1
	RAID 1 Configuration - Mirrored Array	Y	Ν		See note 1
	LSI 3041E 4-Port SAS 3.0 Gb/s RAID Card				
	LSI 3041E 4-Port SAS 3.0 Gb/s RAID Card	Y	Y	EH417AA	See note 2 and 3
	LSI MegaRAID® SAS 8888ELP Host Bus Ada	pter (HBA)			
	LSI 8888ELP 8-port SAS HW RAID Card	Ν	Y	GE258AA	
	SATA hardware RAID is not supported on Linux RAID, provides excellent functionality and perfor RAID. Please visit http://h20000.www2.hp.com/bc/docs/support/Suc capabilities with Linux. All drives must be identical in type and capacity All RAID arrays must be less than 2 TB NOTE 1: Requires identical hard drives (speeds hardware SAS RAID configurations are support http://www.hp.com/support/linux_hardware_mat NOTE 2: Specific user-configured hardware SAS system. Please visit: http://www.hp.com/support NOTE 3: Not supported when HD drive 1 is SAT	mance. It is a gr pportManual/c0 , , capacity, interf ed on this Linux rix for details. S RAID configur t/linux_hardwar	ood alterna 0060684/c0 face. Specit system. Pl ations are s	tive to hardwa 00060684.pdf fic user-config lease visit: supported on t	re-based for RAID ured



Supported Components

Graphics

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Supported Multi Mixed
Professional 2D					
NVIDIA Quadro NVS 450 512 MB PCIe Graphics Card	Y	Y	FH519AA	2nd card must be NVS 295	: 1
NVIDIA Quadro NVS 295 256MB PCIe Graphics Card	Y	Y	FY943AA	2nd card must be NVS 295	2
NVIDIA Quadro NVS 290 256 MB PCIe Graphics Card with 'DMS-59 to Dual DVI cable' included - for Workstations	Ν	Y	GN502AA	1 or 2 of these cards are supported - 2nd card must be NVS 290 or NVS 440	2
Entry 3D					
NVIDIA Quadro FX 380 256MB PCIe Graphics Card	Y	Y	NB769AA		2
ATI FirePro V3700 256MB PCIe Graphics Card	Y	Y	FY944AA		2
NVIDIA Quadro FX 580 512MB PCIe Graphics Card	Y	Y	FY945AA		2
Mid-range 3D					
NVIDIA Quadro FX 1800 768MB PCIe Graphics Card	Y	Y	FY946AA		2
ATI FirePro V5700 512MB PCIe Graphics Card	Y	Y	FY947AA		2
High End 3D					
NVIDIA Quadro FX 3800 1.0GB PCIe Graphics Card (AVAILABLE JUNE 2009)	Y	Y	FY949AA		1
ATI FirePro V7750 1.0GB PCIe Graphics Card	Y	Y	FY948AA		1
NVIDIA Quadro FX 4800 1.5GB PCIe Graphics Card	Y	Y	FQ138AA		1
NVIDIA Quadro CX - The Accelerator for Creative Suite 4	Y	Ν			1



Supported Components Memory сто **Support Notes** PC3-10600 DDR3-1333 ECC Unbuffered DIMMs CTO 1GB (1x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 2GB (2x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 3GB (3x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 4GB (4x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 4GB (2x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 6GB (3x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 8GB (2x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 8GB (4x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 12GB (3x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 16GB (4x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU **Sub-Section Description/Notes** NOTE: Configurations less than 1 GB are not supported on Windows Vista 64 or Vista 64 downgrade to XP 64. DIMMs should be distributed across all three memory channels for optimal performance. Each processor supports up to 3 channels of DDR3 memory. To realize full performance at least 1 DIMM must be inserted into each channel. AMO PC3-10600 DDR3-1333 ECC Unbuffered DIMMs AMO 1GB (1x1GB) DDR3-1333 ECC Unbuffered RAM 2GB (1x2GB) DDR3-1333 ECC Unbuffered RAM 4GB (1x4GB) DDR3-1333 ECC Unbuffered RAM NOTE: Only unbuffered DDR3 DIMMs are supported. Multimedia and Audio Ontion C

Devices		Factory Configured	•	Kit Part Supp Number Note	
	Integrated Intel/Realtek HD ALC262 Audio	Y	Ν		
	HP Thin USB Powered Speakers	Y	Y	KK912AA	
	Creative X-Fi Titanium PCIe Audio Card	Y	Y	NH222AA	



Supported Components

Optical and		Option				
Removable Storage		Factory Configured	Option Kit	Kit Part Number	Support Notes	
	HP 16X DVD-ROM SATA Drive	Y	Y	AR629AA	See note 1	
	HP 16X DVD+-RW SuperMulti SATA Drive	Y	Y	AR630AA		
	HP Blu-ray Writer	Y	Y	AR482AA		
	1.44 MB Diskette Drive (1 only)	Y	Y	NK360AA		
	HP 22-in-1 Media Card Reader Kit (Workstations)	Y	Y	NK361AA		

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE 1: Not supported as a 2nd drive option.

Controller Cards		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP FireWire/IEEE 1394a PCI Card	Y	Y	PA997A	
	HP IEEE 1394b FireWire PCIe Card	Y	Y	NK653AA	
Monitors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP LP1965 19-inch LCD Monitor	Ý	Y	RA373A	
	HP LP2275w 22-inch Widescreen LCD Monitor	Y	Y	KE289A	
	HP LP2475w 24-inch Widescreen LCD Monitor	Y	Y	KD911A	
	HP DreamColor LP2480zx Professional Display	Y	Y	GV546A	
	HP LP3065 30-inch Widescreen LCD Monitor	Y	Y	EZ320A	
	NOTE: Supported by all Operating Systems available	le from HP (scree	en size di	agonally me	easured)



Supported Components

Networking and Communications		Factory Option Configured Kit		Option Kit Part Number	Support Notes
	Integrated Broadcom 5764 PCIe LOM Controller	Y	Ν		
	Broadcom NetXtreme Gigabit Ethernet Plus NIC (PCIe)	Y	Y	FS215AA	This is a PCI Express card based on the Broadcom 5761 chip.
	Intel Gigabit CT Desktop NIC	Ν	Y	FH969AA	
	NOTE 1 : Certain Windows Vista product features http://www.microsoft.com/windowsvista/getready/				ware. See

http://www.microsoft.com/windowsvista/getready/randwarereqs.mspx and http://www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit http://www.windowsvista.com/upgradeadvisor.

"Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Support Number Notes
	Security Cable with Kensington Lock	Ν	Y	PC766A
	HP Solenoid Hood Lock & Hood Sensor			
	HP (CMT) Solenoid Lock	Ν	Y	DE618A
	HP xw4/Z4 Depth Adjustable Fixed Rail Rack Kit	Ν	Y	EK729AA

Input Devices		Factory Configured	Option Kit	Option Kit Part Support Number Notes
	HP PS/2 Standard Keyboard	Y	Y	DT527A
	HP USB Standard Keyboard	Y	Y	DT528A
	HP PS/2 Optical Scroll Mouse	Y	Y	EY703AA
	HP USB 2-Button Optical Scroll Mouse	Y	Y	DC172B
	HP USB Laser Mouse	Y	Y	GW405AA
	HP USB Optical 3-Button Mouse	Y	Y	DY651A
	HP USB Smart Card Keyboard	Ν	Y	ED707AA
	HP 2.4GHz Wireless Keyboard & Mouse	Ν	Y	NB896AA
	HP USB Optical 3-Button 2.9M OEM Mouse	Ν	Y	ET424AA
	HP SpaceExplorer 3D USB Controller	Ν	Y	RY429AA
	HP SpacePilot 3D USB Intelligent Controller	Ν	Y	EF390AA



Supported Components

Other Hardware		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Configure minitower in desktop orientation	Y	Ν		
	HP ENERGY STAR 5.0 Enabled Configuration	Y	Ν		
	HP Workstation Mouse Pad	Y	Ν		Japan only.
	HP eSATA PCI Cable Kit	Y	Y	GM110AA	
	HP Power Cord Kit	Ν	Y	DM293A	
	HP 2nd Serial Port Adapter	Ν	Y	PA716A	
	HP Internal USB Port Kit	Ν	Y	EM165AA	
	HP Optical Bay HDD Mounting Bracket	Ν	Y	NQ099AA	
	HP Workstation to LTO SAS Int. Cable	Ν	Y	EH925A	
	HP Fan and Front Card Guide Kit	Ν	Y	DY648A	

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Tuning Framework	Y	Ν		
	Roxio Easy Media Creator (CD or DVD burner)	Y	Ν		
	Intervideo WinDVD with DVD player	Y	Ν		
	HP Backup and Recovery	Y	Ν		Supported on Windows XP ONLY
	PDF Complete	Y	Ν		
	Microsoft Office 2007 Small Business Edition	Y	Ν		
	Microsoft Office 2007 Trial Edition	Y	Ν		
	HP Client Manager Software v6.2 (optional download)	Y	Ν		
	HP ProtectTools Security	Y	Ν		Must select as a Configure to Order Option. Delivered as a "Drop in the Box" CD



Supported Components

Operating Systems

Genuine Windows Vista® Business 32-bit

Genuine Windows Vista®

Business 64-bit

Support Notes

Certain Windows Vista product features require advanced or additional hardware. See

www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit www.windowsvista.com/upgradeadvisor.

Certain Windows Vista product features require advanced or additional hardware. See

www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit www.windowsvista.com/upgradeadvisor.

Genuine Windows Vista® Business 32-bit with downgrade to Windows® XP Professional 32-bit custom installed

Genuine Windows Vista® Business 64-bit with downgrade to Windows® XP Professional x64 custom installed

HP Linux Installer Kit

Windows Vista Business disk may also be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order at least 25 customer systems with the same custom image.

Windows Vista Business disk may also be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order at least 25 customer systems with the same custom image.

see: http://www.hp.com/workstations/software/linux



F							
System Board							
System Board Form Factor	ATX 9.6 x 12 inches (243.84	4 x 304.8	mm)				
Processor Socket	Single LGA1366						
CPU Bus Speed	QPI: Up to 6.4GT/sec						
Chipset	Intel® X58 Express						
Super I/O Controller	SMSC SCH5327, Rev B						
Memory Expansion Slots	4 DDR3 memory slots						
Memory Type Supported	DDR3, UDIMM (Unbuffered),	, ECC					
Memory Modes	Channel Interleaved						
Memory Speed Supported	800MHz, 1066MHz and 133	3MHz DI	DR3				
Memory Protection	ECC available on data, parit	y on add	ress an	d comm	and		
Memory							
Maximum Memory	NOTE: * Maximum memory capacities assume 64-bit operating systems, such as genuine Windows® Vista Business 64, XP Professional x64 Edition, Red Hat Linux 64-bit. Genuine Windows Vista Business 32 and XP Professional (32-bit) support up to 4 GB. 32-bit Linux supports up to 8 GB.					Linux 64-bit. Genuine	
				-	PUD]
		Capacity 1GB	DEMM1 1GB	DEMM2	DEMING	DIMM4	-
		268	168	168			
		3GB 4GB	1GB 1GB	1CB 1CB	1GB 1GB	108	-
		468	2GB	2GB		1.00	
		6GB 8GB	2GB 2GB	2GB 2GB	2GB 2GB	208	-
		\$GB	468	4G8	100	100	-
		1208	468	408	468		1
		16GB	4GB	4GB	4GB	4GB]
Memory Configuration (Supported)	 The 4GB DIMM for Z4 Z800. They are NOT interchated only ECC DIMMs are 	angeable		NOT con	npatible	with the 4	4GB DIMMs offered on the
PCI Express Connectors (Gen2 Rev 0.7 connectors)	1 x8 PCIe (x4)						
PCI Connectors (5.0V)	2 PCI						
Interfaces Supported	SATA						
Serial Attached SCSI	provides excellent functional Please visit	Hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf for RAID					
Integrated RAID	NOTE: Requires identical hard drives (speeds, capacity, interface)						
	THE TET Rodan of Hadridga He		s (opece	io, oupu	oncy, inter		
Integrated Graphics	No			10, 0upu			



External SATA (eSATA)	4 ports are eSATA configurable with or	otional eSATA After-Market Option cable kit.			
IDE connector	No				
Floppy connector	Yes				
Network Controller	Management capabilities WOL, PXE 2	.1 and ASF 2.0			
Serial	1 internal header (requires optional Ser				
2nd Serial	No	· · ·			
Parallel	No				
Audio	High Definition Integrated Realtek ALC	262 Audio with Line in, Line Out, Microphone, Headphone			
CD-ROM input/Audio	No				
AUX INPUT; Audio	Yes				
IEEE 1394 Connector(s)	Front	1 IEEE 1394a (requires optional PCI card to function)			
	Rear	No			
	Internal	No			
USB Connector(s)	Front	2 USB 2.0			
	Rear	6 USB 2.0			
	Internal	2 USB 2.0 headers			
HD Integrated Audio	High Definition Integrated Realtek ALC	262 Audio with Line in, Line Out, Microphone, Headphone			
Flash ROM	Yes				
Clear Fan Header	No				
CPU Fan Header	Yes				
Chasiss Fan Header	1 Rear System Chassis Fan Header, 1 Optional Front Chassis Fan Header				
Front PCI Fan Header	Yes				
Front Control	Yes				
Panel/Speaker Header					
CMOS Battery Holder -	Yes				
Lithium					
Integrated Trusted Platform Module	Integrated TPM 1.2				
Power Supply Headers	Yes				
Power Switch, Power LED & Hard Drive LED	Yes				
Header					
Clear Password Jumper	Yes				
Serial Port	1 internal header (requires optional Ser	ial Port Adaptor)			
Parallel Port	No				
Keyboard/Mouse	USB or PS/2				
Power Supply	475w 80+ BRONZE, Custom				
Operating Voltage Range	90-269 VAC				
Rated Voltage Range	118V				
Rated Line Frequency	400 Hz				
Operating Line Frequency Range	393-407 Hz				
Rated Input Current	10A @ 118 VAC				
Heat Dissipation	Maximum 2027 btu/hr (511 kg-cal/hr)				
Power Supply Fan	92x25 mm variable speed				



ENERGY STAR® qualified (Config	Yes		
Dependent)			
80 PLUS Compliant	Yes, Bronze		
FEMP Standby Power Compliant 115V (Wake- on LAN disabled) (<2W in S5 - Power Off)			
Power consumption in sleep mode (as defined by ENERGY STAR) - Suspend to RAM (S3)			
Built-in Self Test (BIST) LED	Yes		
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	Yes		
Hood Lock Header	Yes		
Hood Sensor Header	Yes		
ASF 2.0 (Alert Standard Format)	Yes		
Z400 Required Power S	supply into		
Z400 Required Power S Power Supply		475 watt custom power supply	y - (Wide Ranging Active PFC)
· · · · · · · · · · · · · · · · · · ·		475 watt custom power suppl 90 - 26	
Power Supply			
Power Supply Operating Voltage Ran		90 - 26	9 VAC
Power Supply Operating Voltage Ran Rated Voltage Range	ge	90 - 26 100 - 240 VAC	9 VAC 118 VAC
Power Supply Operating Voltage Ran Rated Voltage Range Rated Line Frequency	ge	90 - 26 100 - 240 VAC 50-60 Hz	9 VAC 118 VAC 400 Hz
Power Supply Operating Voltage Ran Rated Voltage Range Rated Line Frequency Operating Line Frequen	ge ncy Range	90 - 269 100 - 240 VAC 50-60 Hz 47 - 66 Hz 10 A @ 110-127 VAC	9 VAC 118 VAC 400 Hz 393 - 407 Hz 10 A @118 VAC (240.3 kg-cal/hr)
Power Supply Operating Voltage Ran Rated Voltage Range Rated Line Frequency Operating Line Frequency Rated Input Current Heat Dissipation (Confi	ge ncy Range	90 - 26 100 - 240 VAC 50-60 Hz 47 - 66 Hz 10 A @ 110-127 VAC 6 A @ 200-240 VAC Typical 954 btu/hr	9 VAC 118 VAC 400 Hz 393 - 407 Hz 10 A @118 VAC (240.3 kg-cal/hr) hr (498.2 kg-cal/hr)
Power Supply Operating Voltage Ran Rated Voltage Range Rated Line Frequency Operating Line Frequen Rated Input Current Heat Dissipation (Confi dependent)	ge ncy Range guration and software	90 - 263 100 - 240 VAC 50-60 Hz 47 - 66 Hz 10 A @ 110-127 VAC 6 A @ 200-240 VAC Typical 954 btu/hr Maximum 1977 btu/	9 VAC 118 VAC 400 Hz 393 - 407 Hz 10 A @118 VAC (240.3 kg-cal/hr) hr (498.2 kg-cal/hr) riable speed
Power Supply Operating Voltage Ran Rated Voltage Range Rated Line Frequency Operating Line Frequency Rated Input Current Heat Dissipation (Confidependent) Power Supply Fan	ge ncy Range guration and software	90 - 26 100 - 240 VAC 50-60 Hz 47 - 66 Hz 10 A @ 110-127 VAC 6 A @ 200-240 VAC Typical 954 btu/hr Maximum 1977 btu/ 92x25 mm va	9 VAC 118 VAC 400 Hz 393 - 407 Hz 10 A @118 VAC (240.3 kg-cal/hr) hr (498.2 kg-cal/hr) riable speed S
Power Supply Operating Voltage Ran Rated Voltage Range Rated Line Frequency Operating Line Frequen Rated Input Current Heat Dissipation (Confidependent) Power Supply Fan Energy Star Compliant 80 PLUS® Compliant	ge ncy Range guration and software (config dependent) Compliant@115V (Wake-	90 - 26 100 - 240 VAC 50-60 Hz 47 - 66 Hz 10 A @ 110-127 VAC 6 A @ 200-240 VAC Typical 954 btu/hr Maximum 1977 btu/ 92x25 mm va YE Yes, B	9 VAC 118 VAC 400 Hz 393 - 407 Hz 10 A @118 VAC (240.3 kg-cal/hr) hr (498.2 kg-cal/hr) riable speed S ronze
Power Supply Operating Voltage Ran Rated Voltage Range Rated Line Frequency Operating Line Frequency Rated Input Current Heat Dissipation (Confidependent) Power Supply Fan Energy Star Compliant 80 PLUS® Compliant FEMP Standby Power Compliant	ge ncy Range guration and software (config dependent) Compliant@115V (Wake- in S5-Power Off)	90 - 26 100 - 240 VAC 50-60 Hz 47 - 66 Hz 10 A @ 110-127 VAC 6 A @ 200-240 VAC Typical 954 btu/hr Maximum 1977 btu/ 92x25 mm va YE Yes, B	9 VAC 118 VAC 400 Hz 393 - 407 Hz 10 A @118 VAC (240.3 kg-cal/hr) hr (498.2 kg-cal/hr) riable speed S ronze S
Power Supply Operating Voltage Ran Rated Voltage Range Rated Line Frequency Operating Line Frequency Operating Line Frequency Rated Input Current Heat Dissipation (Confidependent) Power Supply Fan Energy Star Compliant 80 PLUS® Compliant FEMP Standby Power Con LAN disabled)(<2W EuP Compliant@230V (ge ncy Range guration and software (config dependent) Compliant@115V (Wake- in S5-Power Off) <1 W in S5-Power Off) sleep mode (as defined spend to RAM (S3)	90 - 263 90 - 263 100 - 240 VAC 50-60 Hz 47 - 66 Hz 10 A @ 110-127 VAC 6 A @ 200-240 VAC Typical 954 btu/hr Maximum 1977 btu/ 92x25 mm va YE Yes, B YE	9 VAC 118 VAC 400 Hz 393 - 407 Hz 10 A @118 VAC (240.3 kg-cal/hr) hr (498.2 kg-cal/hr) riable speed S ronze S
Power Supply Operating Voltage Ran Rated Voltage Range Rated Line Frequency Operating Line Frequency Operating Line Frequency Rated Input Current Heat Dissipation (Confidependent) Power Supply Fan Energy Star Compliant 80 PLUS® Compliant FEMP Standby Power Con LAN disabled)(<2W EuP Compliant@230V (Power Consumption in by ENERGY STAR) - Sus	ge ncy Range guration and software (config dependent) Compliant@115V (Wake- in S5-Power Off) <1 W in S5-Power Off) sleep mode (as defined spend to RAM (S3)	90 - 263 90 - 263 100 - 240 VAC 50-60 Hz 47 - 66 Hz 10 A @ 110-127 VAC 6 A @ 200-240 VAC Typical 954 btu/hr Maximum 1977 btu/ 92x25 mm va YE Yes, B YE	9 VAC 118 VAC 400 Hz 393 - 407 Hz 10 A @118 VAC (240.3 kg-cal/hr) hr (498.2 kg-cal/hr) riable speed S ronze S W
Power Supply Operating Voltage Ran Rated Voltage Range Rated Line Frequency Operating Line Frequent Rated Input Current Heat Dissipation (Confidependent) Power Supply Fan Energy Star Compliant 80 PLUS® Compliant FEMP Standby Power Con LAN disabled)(<2W EuP Compliant@230V (Power Consumption in by ENERGY STAR) - Sus (Instantly Available PC)	ge ncy Range guration and software (config dependent) Compliant@115V (Wake- in S5-Power Off) <1 W in S5-Power Off) sleep mode (as defined spend to RAM (S3)) measured at 115V. nging Power Supply	90 - 263 90 - 263 100 - 240 VAC 50-60 Hz 47 - 66 Hz 10 A @ 110-127 VAC 6 A @ 200-240 VAC Typical 954 btu/hr Maximum 1977 btu/ 92x25 mm va YE Yes, B YE Second Second	9 VAC 118 VAC 400 Hz 393 - 407 Hz 10 A @118 VAC (240.3 kg-cal/hr) hr (498.2 kg-cal/hr) riable speed S ronze S S W



System Configuration							
Example Configuration #1	Processor Info Memory Info Graphics Info Disks/Optical/Floppy	1x1GB NVS29	Xeon W38 DDR3 1333 5 8 SATA / 1	3 (UDIMM)	0 Floppy		
	PSU		0 PLUS®		опорру		
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	86.2	23 W	85.2	26 W	85.9	PO W
	Windows Busy Typ(S0)	140.90 W		137.85 W		140.40 W	
	Windows Busy Max (S0)	153.20 W		152.96 W		155.00 W	
	Sleep (\$3)	4.17 W	3.96 W	4.03 W	3.79 W	4.14 W	3.90W
	Off (S5)	1.25 W	1.14 W	1.51 W	1.35 W	1.23 W	1.12 W
	Zero Power Mode (EuP)	0.31 W		0.61 W		0.29W	
Heat Dissipation**		115	VAC	230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	294.30	btu/hr	290.99	btu/hr	293.18	i btu/hr
	Windows Busy Typ (SO)	480.89	btu/hr	470.48 btu/hr		479.19	btu/hr
	Windows Busy Max (S0)	522.87 btu/hr		522.05 btu/hr		529.02 btu/hr	
	Sleep (S3)	14.2 btu/hr	13.5 btu/hr	13.8 btu/hr	12.9 btu/h	14.1 btu/hr	13.3 btu/hr
	Off (S5)	4.27 btu/hr	3.89 btu/hr	5.15 btu/hr	4.61 btu/h	4.20 btu/hr	3.82 btu/hr
	Zero Power Mode (EuP)	1.04	otu/hr	2.06	otu/hr	0.98 btu/hr	



Example Configuration #2	Processor Info Memory Info Graphics Info Disks/Optical/Flopp PSU	4x4GB 1xFX44 by 4x450	800	33MHz (UD Opfical /			
Energy Consumption	T	115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	180.	70 W	178.	30 W	181.	00 W 00
	Windows Busy Typ (SO)	404.	60 W	393.	20 W	407.	50 W
	Windows Busy Max (S0)	482.80 W		469.10 W		488.60 W	
	Sleep (S3)	4.84 W	4.65 W	5.13 W	4.94 W	4.85 W	4.66 W
	Off (S5)	1.18 W	1.07 W	1.61 W	1.37 W	1.16 W	1.05W
	Zero Power Mode (EuP)	0.3	2 W	0.6	1 W	0.2	9 W
Heat Dissipation**	-	115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	616.73	btu/hr	608.54 btu/hr		617.75 btu/hr	
	Windows Busy Typ (SO)	1380.90) btu/hr	1341.99 btu/hr		1390.80) btu/hr
	Windows Busy Max (S0)	1647.80 btu/hr		1601.04 btu/hr		1667.59 btu/hr	
	Sleep (\$3)	16.5 btu/hr	15.9 btu/h	17.5 btu/hr	16.9 btu/h	16.6 btu/hr	15.9 btu/hr
	Off (S5)	4.03 btu/hr	3.65 btu/h	5.49 btu/hr	4.68 btu/h	r 3.96 btu/hr	3.58 btu/hr
	Zero Power Mode (EuP)	1.08	otu/hr	2.06	otu/hr	0.98 btu/hr	



Example Configuration #3	Processor Info Memory Info Graphics Info Disks/Optical/Flopp PSU	3x1GB 1xFX18 by 1x250	el Xeon W DDR3 133 300 GB SATA / 80 PLUS®	3MHz (UD 1 Optical	2.5	ţ	
Energy Consumption	: :	115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	96.7	'O W	95.1	0 W 0	97.7	1 W
	Windows Busy Typ (SO)	237.99 W		233.	03 W	239.	04 W
	Windows Busy Max (S0)	268.79 W		267.95 W		274.90 W	
	Sleep (\$3)	3.89 W	3.65 W	4.20 W	3.96 W	3.83 W	3.61 W
	Off (\$5)	1.20 W	1.06 W	1.51 W	1.35 W	1.17 W	1.02 W
	Zero Power Mode (EuP)	0.31 W		0.60 W		0.29 W	
Heat Dissipation**		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	330.04	btu/hr	324.58 btu/hr		333.48 btu/hr	
	Windows Busy Typ(SO)	812.26	btu/hr	795.33	l btu/hr	815.84	btu/hr
	Windows Busy Max (SO)			914.51 btu/hr		938.23 btu/hr	
	Sleep (S3)	13.3 btu/hr	12.5 btu/hr	14.3 btu/hr	13.5 btu/hr	13.1 btu/hr	12.3 btu/h
	Off (S5)	4.10 btu/hr	3.60 btu/hr	5.15 btu/hr	4.61 btu/hr	3.99 btu/hr	3.48 btu/h
	Zero Power Mode (EuP)	1.05	otu/hr	2.05 btu/hr		0.97 btu/hr	



Example	Processor Info
Configuration #4	Memory Info
(Energy Star	Graphics Info
Compliant)	Disks/Optical/Floppy
	1/0
	PSU

1x Intel Xeon W3570 4x2GB DDR3 1333MHz (UDIMM) 1 x FX4800 2x1000GB SATA / 1 Optical / 1 Floppy 1xBroadcom 5761 Gigabit PCIe NIC 475W SOPLUS® BRONZE

Energy Consumption

Heat Dissipation**

	115 VAC		230	VAC	100 VAC		
	LAN Enabled	LAN Disabled	LAN Endbled	LAN Disabled	LAN Enabled	LAN Disabled	
On-Idle (ENERGY STAR [®] Idle (S0))	99.8	3 W	97.3	7 W	100.	3 W	
ENERGY STAR [®] P _{MAX} Windows running Linpack and Viewperf	323.	1 W	316	.6 W	325.	4 W	
ENERGY STAR [®] "Sleep" (S3)	4.6 W	<u>_</u>	4.8 W	-	4.6 W	<u>-</u> .	
ENERGY STAR [®] "Standby" (Off) (S5)	1.8 W	-	2.1 W	-	1.7 W	-	
	115	AC	230 VAC		100 VAC		
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
On-Idle (ENERGY STAR [®] Idle (S0))	340.6	otu/hr	333.5 btu/hr		342.3 <u>btu</u> /hr		
ENERGY STAR [®] P _{MAX} Windows running Lingapk and Viewperf	1102.7 bty/hr		1080.6 btu/hr		1110.6 btu/hr		
ENERGY STAR [®] "Sleep" (S3)	15.7 btu/hr	-	16.4 btu/hr	-	15.7 btu/hr	-	
ENERGY STAR [®] "Standby" (Off) (S5)	1.8 btu/hr	-	2.1 bty/hr	-	1.7 btu/hr	-	

NOTES:

* Energy Star low energy mode

** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions (Entry-level and High-end configurations)						
System Configuration	Processor Info	Intel Xeon Processor W3505 2.53 GHz				
(Entry level)	Memory Info	4 x 1GB DDR3 1333 MHz				
	Graphics Info	NVIDIA Quadro NVS 295				
	Disks/Optical/Floppy	1 x 160 GB 7200 RPM SATA / DVD-ROM / No Floppy				

Declared Noise		Sound Power (LWAd, bels)	Deskside Sound Pressure
Emissions (in	Idle	3.9 Bels	23 dB
accordance with ISO 7779 and ISO 9296)	SATA Hard drive Operating (random reads)	4.2 Bels	25 dB
	Floppy Drive Operating (continuous copy)	4.7 Bels	29 dB
	DVD-ROM Operating (sequential reads)	5.1 Bels	38 dB



System Configuration	Processor Info	Intel Xeon Processor W3570 3.20 GHz
(High-end)	Memory Info	4 x 1GB DDR3 1333 MHz
	Graphics Info	NVIDIA Quadro FX 4600
	Disks/Optical/Floppy	2 x 450 GB 15K SAS / DVD-ROM / No Floppy

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure
	Idle	4.6 Bels	27 dB
	SATA Hard drive Operating (random reads)	5.2 Bels	35 dB
	Floppy Drive Operating (continuous copy)	5.0 Bels	32 dB
	DVD-ROM Operating (sequential reads)	5.3 Bels	38 dB

Environmental Requirements	Temperature	Operating: 40° to 95° F (5° to 35° C) Non-operating: -40° to 140° F (-40° to 60° C)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 10,000 feet (3,000 m) Non-operating: 30,000 feet (9,100 m)
	Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms Non-operating: ½-sine: 160 cm/s, 2-3ms (~100g) square: 422 cm/s, 20g NOTE: Values represent individual shock events and do not indicate repetitive shock events. Vibration Operating random: 0.5g (rms), 5-300 Hz Non-operating random: 2.0g (rms), 10-500 Hz NOTE: Values do not indicate continuous vibration.
	Cooling	Above 5000 ft (1524 m) altitude, maximum operating temperature is derated by 1.8° F (1° C) per 1000 ft (305 m) elevation increase

Physical Security and Serviceability		
Access Panel	Tool-less Includes system board and memory information	
Optical Drive	Tool-less	
Floppy Drive	Tool-less	
Hard Drives	Tool-less	
Expansion Cards	Tool-less	
Processor Socket	Tool-less	
Green User Touch Points	Yes, on tool-free internal chassis components	
Color-coordinated Cables and Connectors	Yes	
Memory	Tool-less	



System Board	Tool-less
Dual Color Power and HD LED on Front of Computer	Yes
Configuration Record	Yes
Over-Temp Warning on Screen	Yes
Restore CD Set	Restores the computer to its original factory shipping image - Can be obtained via HP Support
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 0.22-in diameter padlock loop at rear of system
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system
Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed
Rear Port Control Cover	Yes, locks rear IO cables to prevent cable theft
Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes, enables or disables serial, USB, audio, and network ports
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration
3.3V Aux Power LED or System PCA	Yes
NIC LEDs (integrated) (Green & Amber)	Yes
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less
Power supply diagnostic LED	Yes
Power Button	Yes, ACPI multi-function
Power LED	Yes, blue (normal), red (fault)
Hard drive activity LED	Yes, green
Internal speaker	Yes
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.
OS CD (Restore OS CD)	Restores computer to its original factory shipping Operating System - No recovery CDs will ship with Windows XP, Vista or Linux - an ISO image will be available on an HD partition.
ASF 2.0 support (Alert Standard Format)	Industry-standard specification for network alerting in operating system-absent environments
otandara i ormatj	



Power Supply Fans	92 mm x 92 mm x 25 mm 2-wire (non-serviceable)		
CPU Heatsink Fan(s)	Mainstream (<=95W): 80 mm x 80 mm x 15 mm 5-wire PWM Performance (>95W): 92 mm x 92 mm x 25 mm 5-wire PWM		
Chassis Fans	92 mm x 92mm x 25 mm 4-wire PWM		
Memory Fans	No		
Insight Diagnostics	HP Insight Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to:		
	 Run diagnostics iew the hardware configuration of the system 		
	Key features and benefits HP Insight Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest insight into potential system issues, is the configuration of the system. Insight Diagnostics helps provide higher system availability. Typical uses of the Insight Diagnostics are:		
	 Testing and diagnosing apparent hardware failures Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance Sending configuration information to another location for more in-depth analysis 		
Access Panel Key Lock	No		
ACPI-Ready Hardware	 Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system 		
Trusted Platform Module Chip with optional ProtectTools Software	Yes, Infineon SLB9635TT1.2		
Integrated Chassis Handles	No		
Power Supply	Requires T15 Torx or flat blade screwdriver		
PCI Card Retention	Yes, rear (all), middle (none), front (full-length cards with extender)		
Flash ROM	Yes		
Diagnostic Power Switch LED on board	Yes		
Clear Password Jumper	Yes		
Clear CMOS Button	Yes		
CMOS Battery Holder for easy Replacement	Yes		
DIMM Connectors for easy Upgrade	Yes		
HP ProtectTools Security Manager	Yes - Not supported on Microsoft XP x64 or Linux		



BIOS		
BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal v0.4	
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.	
ΑΤΑΡΙ	ATAPI Removable Media Device BIOS Specification Version 1.0.	
BBS	BIOS Boot Specification v1.01.	
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.	
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.	
BIOS Power On	Users can define a specific date and time for the system to power on.	
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS.	
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.	
Replicated Setup	Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).	
SMBIOS	System Management BIOS 2.6, for system management information.	
Boot Control	Disables the ability to boot from removable media on supported devices.	
Memory Change Alert	Alerts management console if memory is removed or changed.	
	 NORMAL - normal temperature ranges ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs 	
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.	
ACPI (Advanced Configuration and Power Management Interface)	 Allows the system to enter and resume from low power modes (sleep states).] Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems. 	
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.	
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location.	
ASF 2.0 Compliant	Allows workstation status to be monitored on a remote console.	
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.	
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system.	
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.	
System board revision level	 Allows management SW to read the revision level of the system board Revision level is digitally encoded into the HW and cannot be modified. 	



Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.
Auto Setup when new hardware installed	System automatically detects addition of new hardware.
Keyboard-less Operation	The system can be booted without a keyboard.
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.
Asset Tag	The user or MIS to set a unique tag string in non-volatile memory.
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.
Adaptive Cooling	Control parameters are set according to detected hardware configuration for optimal acoustics.
Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED.
Industry Standard Specification Support	
Industry Standard	Revision Supported by the BIOS
ACPI	Advanced Configuration and Power Management Interface, Version 2.0c
ASF	Alert Standard Format Specification, Version 2.0
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0
EDD	 Enhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0
PCI	 PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7
PCI Express	PCI Express Base Specification, Revision 2.0
РММ	POST Memory Manager Specification, Version 1.01
SATA	 Serial ATA Specification, Revision 1.0a Serial ATA 3.0Gb/s: Extensions to Serial ATA 1.5Gb/s, Revision 1.0
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
ТРМ	Trusted Computing Group TPM Specification Version 1.2
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1
USB 1.1	Universal Serial Bus Revision 1.1 Specification
USB 2.0	Universal Serial Bus Revision 2.0 Specification
SMBIOS	System Management BIOS Reference Specification, Version 2.6

System Software	Management and Updating
HP Client Management Solutions	Visit: http://www.hp.com/go/easydeploy
Product Change	 Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile. PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition. Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.
Support Software CD & WWW	Yes
HP Client Manager	Visit: http://www.hp.com/go/easydeploy
System Software Manager (free)	Visit: http://www.hp.com/go/ssm
Ø	



Social and Environmental Responsibility	
	s This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:
	 ENERGY STAR® (energy-saving features available on selected configurations -Windows only)
	US Federal Energy Management Program (FEMP)
	 China Energy Conservation Program IT ECO declaration
	Japan PC Green label*
	*This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.'
Batteries	This product complies with ISO standards:
	EU Directive 91/157/EEC
	 EU Directive 93/ 86/ EEC EU Directive 98/ 101/ EEC
	Batteries used in the product do not contain:
	 Mercury greater than 5ppm by weight
	Cadmium greater than 10ppm by weight
	 Lead greater than 4000ppm by weight
	Battery size: CR2032 (coin cell) Battery type: Lithium
Restricted Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):
	Asbestos
	Batteries - Mercury
	 Batteries - Cadmium Batteries - Lead (non-rechargeable)
	 Batteries - Non-rechargeable Alkaline and Carbon-Zinc Batteries
	Batteries - Classification as "Not Restricted" for Transport
	 Brominated Flame Retardants (PBBs, PBDEs, including DecaBDE) Brominated Flame Retardants (all BFRs in external case plastic parts)
	 Cadmium and its compounds
	Certain Azo Colorants
	 Chlorinated Hydrocarbons Chlorinated Paraffins
	 Formaldehyde
	Formaldehyde - emissions
	Hexavalent Chromium and its compounds in metallic applications
	 Hexavalent Chromium and its compounds in metallic applications Hexavalent Chromium and its compounds in non-metallic applications
	 Hexavalent Chromium and its compounds in metallic applications Hexavalent Chromium and its compounds in non-metallic applications Lead and its compounds
	 Hexavalent Chromium and its compounds in metallic applications Hexavalent Chromium and its compounds in non-metallic applications Lead and its compounds Lead in paint Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords
	 Hexavalent Chromium and its compounds in metallic applications Hexavalent Chromium and its compounds in non-metallic applications Lead and its compounds Lead in paint Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords Mercury and its compounds
	 Hexavalent Chromium and its compounds in metallic applications Hexavalent Chromium and its compounds in non-metallic applications Lead and its compounds Lead in paint Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords Mercury and its compounds Nickel on external surfaces
	 Hexavalent Chromium and its compounds in metallic applications Hexavalent Chromium and its compounds in non-metallic applications Lead and its compounds Lead in paint Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords Mercury and its compounds Nickel on external surfaces Ozone Depleting Substances (ODS)
	 Hexavalent Chromium and its compounds in metallic applications Hexavalent Chromium and its compounds in non-metallic applications Lead and its compounds Lead in paint Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords Mercury and its compounds Nickel on external surfaces
	 Hexavalent Chromium and its compounds in metallic applications Hexavalent Chromium and its compounds in non-metallic applications Lead and its compounds Lead in paint Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords Mercury and its compounds Nickel on external surfaces Ozone Depleting Substances (ODS) Polycyclic Aromatic Hydrocarbons (PAH) Perfluorooctane sulfonates (PFOS) in parts Perfluorooctane sulfonates (PFOS) in preparations
••••••••••••••••••••••••••••••••••••••	 Hexavalent Chromium and its compounds in metallic applications Hexavalent Chromium and its compounds in non-metallic applications Lead and its compounds Lead in paint Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords Mercury and its compounds Nickel on external surfaces Ozone Depleting Substances (ODS) Polycyclic Aromatic Hydrocarbons (PAH) Perfluorooctane sulfonates (PFOS) in parts
۰	 Hexavalent Chromium and its compounds in metallic applications Hexavalent Chromium and its compounds in non-metallic applications Lead and its compounds Lead in paint Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords Mercury and its compounds Nickel on external surfaces Ozone Depleting Substances (ODS) Polycyclic Aromatic Hydrocarbons (PAH) Perfluorooctane sulfonates (PFOS) in parts Perfluorooctane sulfonates (PFOS) in preparations

	Specifications
	Polychlorinated Naphthalenes
	Polyvinyl Chloride (PVC) in external case plastic parts
	Radioactive Substances
	Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging	HP Workstation product packaging meets the following (refer to the HP General Specification for
	the Environment at
	http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html:
	Does not contain restricted substances listed in HP Standard 011-1 General Specification
	for the Environment (see link above).
	 Does not contain ozone-depleting substances (ODS).
	 Design packaging materials for ease of disassembly.
	Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess
	of 100 ppm sum total for all heavy metals listed.
	Maximizes the use of post-consumer recycled content materials in packaging materials.
	All packaging material is recyclable.
	 Reduces size and weight of packages to improve transportation fuel efficiency.
	Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
Longevity and	This product is designed to be upgraded, possibly extending its useful life by several years. Spare
Upgrading	parts are available throughout the warranty period and for up to 5 years after the end of
	production. Upgradeability features contained in the product include:
	Intel LGA775 processor socket
	a 12 LISP porta
	12 USB ports 0 7 rear
	 O 3 internal - 1 Type A O 2 front
	• 3 PCI slots
	 4 PCI Express slots
	• 4 PCI Express slots • 1 PCI Express ×1 slot
	o 2 Gen2 PCI Express ×16 slots
Packaging Materials	
	Cardboard carter and incert 1 520 kg
External	Cardboard carton and insert: 1.536 kg
Internal	LDPE Foam: .366 kg
End-of-Life	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic
Management and	areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest
Recycling	HP sales office. Products returned to HP will be recycled, recovered or disposed of in a
	responsible manner.
Hewlett-Packard	For more information about HP's commitment to the environment:
Corporate	[link to new HP white paper now in progress]
Environmental	Global Citizenship Report: http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
Information	Eco-label certifications:
	http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html
	ISO 14001 certificates:
	http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html
Service, Support and	On-site Warranty and Service (Note 1): One and three-years, limited warranty and service offering
Warranty	delivers on-site, next business-day (Note 2) service for parts and labor and includes free telephone
	support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one
	country and transferred to another, non-restricted country will remain fully covered under the
	original warranty and service offering
	NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.
	NOTE 2: On-site service may be provided pursuant to a service contract between HP and an
	authorized HP third-party provider, and is not available in certain countries. Global service
	response times are based on commercially reasonable best effort and may vary by country.
	NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-
	party hardware and software. Toll-free calling and 24 x 7 support may not be available in some
	countries.



	HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location
Additional Information	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.
	 This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
	• Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
	 This product contains 0% recycled materials (by weight) This product is >90% recycle-able when properly disposed of at end of life.



Technical Specifications - Processors

Processors	Intel Xeon W3503, 2.40GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core
	Intel Xeon W3505, 2.53GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core
	Intel Xeon W3520, 2.66GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo
	Intel Xeon W3540, 2.93GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo
	Intel Xeon W3570, 3.20GHz, 8MB cache, 1333 memory, 6.4GT/s, Quad-Core, HT, Turbo

Introduction

Intel's latest-generation microarchitecture represents the next step in unprecedented processor performance and dynamic scalability. Designed from the ground up to take advantage of hafnium-based Intel® 45nm hi-k metal gate silicon technology, Intel® Microarchitecture (Nehalem) unleashes parallel processing performance enabled by Intel® QuickPath technology providing an integrated memory controller and high-speed interconnect per independent processing core.

Performance and Features

Maximum multitasking performance Intel® Microarchitecture (Nehalem) offers the latest in processor innovation, including:

- 'Dynamic scalability, managed cores, threads, cache, interfaces, and power for energy-efficient performance on demand.
- Design and performance scalability for servers, workstations, notebooks and desktops with support for 2-8+ cores and up to 16+ threads with Intel® Hyper-Threading Technology (Intel® HT Technology), and scalable cache sizes, system interconnects, and integrated memory controllers.
- Intel® Turbo Boost Technology delivers additional performance automatically when needed by taking advantage of the processor's power and thermal headroom. This enables increased performance of both multi-threaded and singlethreaded workloads.
- Intel Hyper-Threading Technology brings high-performance applications into mainstream computing with 1-16+ threads optimized for a new generation multi-core processor architecture.
- Scalable shared memory of Intel® QuickPath technology features memory distributed to each processor with integrated memory controllers and high-speed point-to-point interconnects to unleash the performance of future versions of next-generation Intel® multi-core processors.
- Multi-level shared cache improves performance and efficiency by reducing latency to frequently used data.

Turbo Boost Technology

This technology now built into Xeon 3500 Series Quad-Core processors will increase the speed of your processor on demand (from OS) if the CPU is operating below power / thermal specifications:

- Benefit of Turbo Boost (how much CPU speed up) depends on number of active cores
- Likelihood of Turbo Boost operation increases when less cores are active
- Likelihood of Turbo Boost operation increases when dynamic power mgt is enabled



Technical Specifications - Hard Drives

HP SAS (Serial	300 GB	Capacity	300 GB	
Attached SCSI) Hard Drives for HP	(15K)	Height	1 in; 2.5 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
Workstations			Physical Size	4 in; 10.2 cm
		Interface	SAS	,
		Synchronous Transfer Rate (Maximum)		
		Buffer	16 MB	
		Seek Time (typical	Single Track	0.2 ms
		reads, includes controller		3.5 ms
		overhead, including settling)	Full Stroke	6.7 ms
		Rotational Speed	15,000 rpm	
		Logical Blocks	585,937,500 - 512 byte l	olocks
		Operating Temperatur	e 50° to 95° F (10° to 35° (C)
	146 GB	Capacity	146 GB	
	(15K)	Height	1 in; 2.5 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.2 cm
		Interface	SAS	
		Synchronous Transfer Rate (Maximum)	3.0 Gb/s	
		Buffer	16 MB	
		Seek Time (typical	Single Track	0.2 ms
		reads, includes controller overhead, including	^r Average Full Stroke	3.5 ms 6.7 ms
		settling)		0.7 113
		Rotational Speed	15,000 rpm	
		Logical Blocks	86,749,488 - 512 byte bl	
		Operating Temperatur	e 50° to 95° F (10° to 3°5 (J)
	450 GB (15K)	Capacity	450 GB	
		Height	1 in; 2.5 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.2 cm
		Interface	SAS	
		Synchronous Transfer Rate (Maximum)	3.0 Gb/s	
		Buffer	16 MB	
		Seek Time (typical	Single Track	0.2 ms
		reads, includes controller	Average	3.6 ms
		overhead, including settling)	Full Stroke	6.6 ms
		Rotational Speed	15,000 rpm	
		Logical Blocks	879, 097, 968 - 512 byte	blocks
		-	e 50° to 95° F (10° to 35° (
			``	-



SATA (Serial ATA) Hard Drives for HP Workstations 160,041,885,696 bytes bytes 160,041,885,696 bytes 1 in; 2.5 cm Width Media Diameter Serial ATA (1.5 Gb/s), Native Command Queuing enabled 3.5 in; 8.9 cm Synchronous Transfer Rate (Maximum) Buffer 6 Mbytes Seek Time (typical reads, includes controller overhead, including setting) Up to 150 MB/s	Technical Specifications - Hard Drives				
Hard Drives for HP Workstations bytes (10K) Height With 1 in; 2.5 cm With Media Diameter Physical Size Serial ATA (1.5 Gb/s), Native Command Queuing enabled 3.5 in; 8.9 cm Synchronous Transfer Rate (Maximum) Up to 150 MB/s 4 in; 10.2 cm Buffer 16 Mbytes Single Track 0.3 ms Seek Time (typical reads, including setting) 1000 rpm 3.5 in; 8.9 cm Rotational Speed Logical Blocks 312,581,808 0.3 ms Operating (7,200) Capacity 1,000,204,886,016 51 is; 8.9 cm Physical Size (7,200) 1000,204,886,016 1 in; 2.5 cm 3.5 is; 8.9 cm Physical Size (7,200) 1,000,204,886,016 1 in; 2.5 cm 3.5 is; 8.9 cm Physical Size (7,200) 1,000,204,886,016 51 is; 8.9 cm Physical Size (7,200) 1 in; 2.5 cm 4 in; 10.2 cm Interface Serial ATA (3.0 Gb/s), Native Command Queuing enabled 3.5 is; 8.9 cm Synchronous Transfer Rate (Maximum) 22 MB Single Track 2 ms Suffer 32 MB Single Track 2 ms Suffer 32 MB Single Track 2 ms Logical Blocks 0,35 055,5168 1 ms Operating 10 is 13" F (5" to 55" C) 1 ms Full Stroke 21 ms	SATA (Serial ATA)	160,041,885,696	Capacity	160,041,885,696 byt	es
With We dua Diameter 3.5 in; 8.9 cm Prysical Size 4 in; 10.2 cm Interface Serial ATA (1.5 Gb/s), Native Command Queuing enabled Synchronous Transfer Rate (Maximum) Up to 150 MB/s Buffer 16 Mbytes Seek Time (typical reads, includes) Single Track 0.3 ms Full Stroke 4.6 ms controller overhead, including setting) 10.000 rpm Including setting) 10.000 rpm Logical Blocks 312,581,808 Operating 1000,204,886,016 bytes (7.200) Capacity 1,000,204,886,016 bytes Height 1 in; 2.5 cm Width Media Diameter 3.5 in; 8.9 cm Physical Size 4 in; 10.2 cm Interface Serial ATA (3.0 Gb/s), Native Command Queuing enabled Synchronous (Transfer Rate controller overhead, including setting) 1 in; 2.5 cm Buffer 32 MB Sugle Track 2 ms Single Track 2 ms Including setting) 7.200 rpm Logical Blocks 1,953,525,168 Operating 7.200 rpm Logical Blocks 1,953,525,168 Operating 7.200 rpm Logical Blocks 1,953,525,168 Operating Hei		-	Height	-	
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enabled in the interval of the				Physical Size	4 in; 10.2 cm
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including setting) Full Stroke 10.2 ms Rotational Speed 10,000 rpm Logical Blocks 312,581,808 Operating 11* to 131* F (5* to 55* C) Full Stroke 1 1,000,204,886,016 Capacity 1,000,204,886,016 bytes Image: Specific Stroke S				Average	4.6 ms
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including settling) Rotational Speed Logical Blocks Operating Temperature 500,107,862,016 bytes (7,200) Capacity Height (7,200) Capacity Height 1 in; 2.5 cm Vidth Media Diameter Physical Size 4 in; 10.2 cm Interface Synchronous Transfer Rate (Maximum) Full Stroke 1,953,525,168 1,953,525,168 500,107,862,016 bytes 500,107,862,016 bytes 4 in; 10.2 cm 3.5 in; 8.9 cm Physical Size 4 in; 10.2 cm 300 MB/s				Average	11 ms
Rotational Speed Logical Blocks7,200 rpm 1,953,525,168Soo,107,862,016 bytes (7,200)Capacity Height500,107,862,016 bytes 1 in; 2.5 cmSoo,107,862,016 WidthMedia Diameter Physical Size enabled3.5 in; 8.9 cm Physical Size enabledSynchronous Transfer Rate (Maximum)Soo MB/s				Full Stroke	21 ms
Logical Blocks Operating Temperature 500,107,862,016 bytes (7,200) Capacity Height (7,200) Capacity Height (7,200) Capacity Height (7,200) Superature Height Media Diameter Physical Size Serial ATA (3.0 Gb/s), Native Command Queuing enabled Synchronous Transfer Rate (Maximum) Superature 1,953,525,168 41° to 131° F (5° to 55° C) 500,107,862,016 bytes 1 in; 2.5 cm Physical Size 4 in; 10.2 cm Interface Superature 300 MB/s				7,200 rpm	
Temperature500,107,862,016 bytes (7,200)Capacity Height Width500,107,862,016 bytes 1 in; 2.5 cm Wedia Diameter Physical Size(7,200)WidthMedia Diameter Physical SizeInterfaceSerial ATA (3.0 Gb/s), Native Command Queuing enabledSynchronous Transfer Rate (Maximum)300 MB/s			-	•	
bytes (7,200)Height1 in; 2.5 cmWidthMedia Diameter3.5 in; 8.9 cmPhysical Size4 in; 10.2 cmInterfaceSerial ATA (3.0 Gb/s), Native Command Queuing enabledSynchronous Transfer Rate (Maximum)300 MB/s				41° to 131° F (5° to 5	55° C)
(7,200) Width Media Diameter 3.5 in; 8.9 cm Physical Size 4 in; 10.2 cm Interface Synchronous Transfer Rate (Maximum) Synchronous		500,107,862,016	Capacity	500,107,862,016 byt	es
With Media Diameter 3.5 In, 8.9 cm Physical Size 4 in; 10.2 cm Interface Serial ATA (3.0 Gb/s), Native Command Queuing enabled Synchronous 300 MB/s Transfer Rate (Maximum) 300 MB/s		-	Height	1 in; 2.5 cm	
Interface Serial ATA (3.0 Gb/s), Native Command Queuing enabled 300 MB/s Transfer Rate (Maximum)		(7,200)	Width	Media Diameter	3.5 in; 8.9 cm
enabled Synchronous 300 MB/s Transfer Rate (Maximum)				Physical Size	4 in; 10.2 cm
Transfer Rate (Maximum)			Interface), Native Command Queuing
			Transfer Rate	300 MB/s	
				16 MB	



Technical Specifications - Hard Drives

		Seek Time (typical	Single Track	2 ms
		reads, includes	Average	11 ms
		controller overhead, including settling)	Full Stroke	21 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	976,773,168	
		Operating	41° to 131° F (5° to 55	° C)
		Temperature		
	250 GB	Capacity	250 GB	
	(7200 rpm, for HP Z-	Height	1 in; 2.54 cm	
	Workstations)	Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4.0 in; 10.17 cm
		Interface	•	Native Command Queuing
		Synchronous Transfer Rate (Maximum)	300 MB/s	
		Buffer	8 MB	
		Seek Time (typical	Single Track	2 ms
		reads, includes controller overhead, including settling)	Average	11 ms
			Full Stroke	21 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	488,397,168	
		Operating Temperature	41° to 131° F (5° to 55	° C)
	160,041,885,696	Capacity	160,041,885,696 bytes	3
	bytes	Height	1 in; 2.5 cm	
	(7,200)	Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.2 cm
		Interface	Serial ATA (3.0 Gb/s), enabled	Native Command Queuing
		Synchronous Transfer Rate (Maximum)	300 MB/s	
		Buffer	8 MB	
		Seek Time (typical	Single Track	2 ms
		reads, includes controller overhead,	Average	11 ms
		including settling)	Full Stroke	21 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	312,581,808	
		Operating Temperature	41° to 131° F (5° to 55	° C)
	300,069,052,416	Capacity	300,069,052,416 bytes	
	bytes	Height	0.6 in; 1.53 cm	,



Technical Specifications - Hard Drives

	(10K)	Width	Media Diameter Physical Size	2.5 in; 6.36 cm 4 in; 10.17 cm	
		Interface	Serial ATA (3.0Gb/s), Native Command Queuing enabled		
		Synchronous Transfer Rate (Maximum)	Up to 300 MB/s		
		Buffer	16 MB		
		Seek Time (typical	Single Track	0.7 ms (maximum)	
		reads, includes controller overhead,	Average	4.4 ms	
		including settling)	Full Stroke	9.5 ms	
		Rotational Speed	10,000 rpm		
		Logical Blocks	586,072,368		
		Operating Temperature	41° to 131° F (5° to 55°	° C)	
	320,072,933,376	Capacity	320,072,933,376 bytes	i	
	bytes	Height	0.98 in; 2.5 cm		
	(7,200)	Width	Media Diameter	3.5 in; 8.9 cm	
			Physical Size	4.0 in; 10.17 cm	
		Interface	Serial ATA (3.0 Gb/s), enabled	Native Command Queuing	
		Synchronous Transfer Rate (Maximum)	300 MB/s		
		Buffer	8 MB		
		Seek Time (typical	Single Track	2	
		reads, includes controller overhead,	Average	12	
		including settling)	Full Stroke	21	
		Rotational Speed	7,200 rpm		
		Logical Blocks	625,142,448		
		Operating Temperature	41° to 131° F (5° to 55°	° C)	



Technical Specifications - Hard Drive Controllers

LSI 3041E 4-Port SAS	PCI Bus	PCI-Express x4 lanes	
3.0 Gb/s RAID Card	PCI Modes	Bus Master DMA	
	RAID Levels	RAID 0, 1, 1E and 10E	
	PCI Data Burst	250 MB/s per lane half of	duplex
	Transfer Rate	500 MB/s per lane full d	•
		1,000 MB/s 4-lane half o	-
	SAS Bandwidth	Half Duplex	Single lane – 300 MB/s Wide Port (2 lanes) – 600 MB/s Wide Port (4 lanes) – 1200 MB/s
		Full Duplex	Single SAS Lane – 600 MB/s Wide Port (2 lanes) –1200 MB/s Wide Port (4 lanes) – 2400 MB/s
	PCI Card Type	3.3 volt add-in c	
	PCI Voltage	12 V ± 10%	
	PCI Power	7.5 Watts	
	Bracket	Full height and Low-prof	ïle
	Certification Level	PCI-Express 1.0a	
	IO Bus	Four 3 Gb/s SAS/SATA	ports
	SAS Processor	LSISAS1064E	
	Internal Connectors	Four- SATA x1 connect	ors
	External Connectors	None	
	Maximum Number of SCSI Devices	122	
	LED Indicators	On-board activity and fa	ult LEDs
	Integrated Mirroring	Integrated Mirroring optic	on available
LSI MegaRAID® SAS	PCI Bus	PCI-Express x8 lanes	
8888ELP Host Bus	PCI Modes	Bus Master DMA	
Adapter (HBA)	RAID Levels	RAID 0, 1, and 5 RAID spans 10 and 50	
	PCI Data Burst Transfer Rate	Up to 3Gb/s per port	
	Full Duplex	Up to 1.5 GB/s	
	PCI Voltage	+3.3V Add-in Card	
	PCI Power	7.5 Watts	
	Certification Level	PCI-Express 1.0a	
	IO Bus	Eight 3Gb/s SAS/SATA	ports
	Internal Connectors	Two SAS SFF8087 x4	
	External Connectors	Two SAS SFF8088 x4	
	Maximum Number of SCSI DeviceS	32	
	LED Indicators	Connector LEDs indicate active for ports 0-3 and 4	e whether the internal or external connector is 1-7



Technical Specifications - Graphics

NVIDIA Quadro NVS 450 512 MB PCIe	Form Factor	ATX Full Height, 1/2 length Passive cooling
Graphics Card	Bus Type	PCI Express x16, Generation 2.0
	Memory	512 MB GDDR3 (256MB per GPU)
	Connectors	Four DisplayPort; Four DisplayPort to DVI-D adapters included. ('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory)
	Maximum Resolution	DisplayPort connectors support ultra-high-resolution panels (up to 2560 x 1600)
	Supported Graphics APIs	OpenGL 3.0 Direct X 10.0
	Available Graphics Drivers	Genuine Microsoft Windows Vista(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation HP qualified drivers may be preloaded or available from the HP support web site: http://welcome.hp.com/country/us/eng/software_drivers.html. Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
	Power consumption	35 Watts
NVIDIA Quadro NVS	Form Factor	2.731 inches (H) × 6.600 inches (L), Half-Height
295 256MB Graphics	Graphics Controller	NVIDIA Quadro NVS 295 Graphics Board
Card	Bus Type	PCI Express x16, Generation 2.0
	Memory	256 MB GDDR3 SDRAM unified graphics memory
	Connectors	2 DisplayPort
	Connectors	Comes with 2 DisplayPort to DVI-D Adapters ('DisplayPort to VGA' and 'DisplayPort to DL DVI' adapters available as an accessory)
	Maximum Resolution	Two DisplayPort outputs drive two digital displays up to 2560 x 1600
	Display Output	 Drives DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking Drives DVI enabled digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking (through DisplayPort to DVI-D (single link) cable)
	Supported Graphics APIs	OpenGL 3.0 DirectX 10.0
	Available Graphics Drivers	Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
		Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
	Power consumption	22.69 Watts



Technical Specifications - Graphics

NVIDIA Quadro NVS	Form Factor	Low Profile
290 256 MB PCIe	Bus Type	PCle x16
Graphics Card	Memory	256 MB 400MHz DDR2 SDRAM unified frame buffer, Z-buffer and Texture storage
	Connectors	DMS-59, includes DMS-59 to Dual DVI-I cable. DMS-59 to Dual VGA cable available as an option.
	Maximum Resolution	Dual integrated analog display controllers supporting up to two analog displays at 2048x1536 @ 85Hz on both displays or dual digital displays at 1920x1200 (single-link). NVIEW advanced multi-display desktop and application management seamlessly integrated into Microsoft® Windows®
	RAMDAC	Integrated dual 400MHz
	Image Quality Feature	s Full-screen, full-frame video playback of HDTV and DVD content DVD-ready motion compensation for MPEG-2 Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0) IDCT motion compensation 5-tap horizontal by 3-tap vertical filtering 8:1 up/down scaling
	Programmable Video Processor	Full-screen, full-frame video playback of HDTV and DVD content DVD-ready motion compensation for MPEG-2 Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0) IDCT motion compensation 5-tap horizontal by 3-tap vertical filtering 8:1 up/down scaling
	Display Output	Dual integrated analog display controllers supporting up to two analog displays at 2048x1536 @ 85Hz on both displays or dual digital displays at 1920x1200 (single-link). NVIEW advanced multi-display desktop and application management seamlessly integrated into Microsoft® Windows®
	Supported Graphics APIs	OGL 2.1 & DX10 Support; Shader Model 4.0
	Available Graphics Drivers	Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit)(Provides full native Dual View mode, Span or Big Desktop mode, and Clone mode) Red Hat Enterprise Linux(RHEL) WS3, WS4 & 5 Desktop/Workstation HP qualified drivers may be preloaded or available from the HP support web site: http://welcome.hp.com/country/us/eng/software_drivers.html. Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
	High-Resolution AntiAliasing CUDA™ Parallel Processor Cores	Color planes: 32-bit color buffer Overlay planes: Hardware supported NVIDIA Quadro NVS 290 (256 MB DH) PCIe Graphics Card with full height bracket attached, DMS-59 to Dual DVI cable, Workstation Software Driver CD, documentation.



Technical Specifications - Graphics

NVIDIA Quadro FX 380	Form Factor	4.376 inches (H) × 6.60 inches (L)
256MB Graphics Card	Graphics Controller	NVIDIA Quadro FX 380 Graphics Board
	Bus Type	PCI Express x16, Generation 2.0
	Memory	256 MB GDDR3 SDRAM unified graphics memory
	Connectors	2 Dual Link DVI-I Two DVI-I to VGA adapters included
	Maximum Resolution	Two dual-link DVI-I outputs drive two digital displays at resolutions up to 2560 x 1600 @ 60Hz or two analog displays at resolutions up to 2048 x 1536 @ 85Hz
	RAMDAC	Dual Internal 400 MHz DAC
	Shading architecture	Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)
		 Long fragment programs (unlimited instructions) Long vertex programs (unlimited instructions) Looping and subroutines (up to 256 loops per vertex program) Dynamic flow control Conditional execution
	Supported graphics APIs	OpenGL 3.0 Direct X 10.0
	Available graphics drivers	Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
		Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
	High-level Shader Languages	 Optimized compiler for Cg and Microsoft HLSL OpenGL 2.1 and DirectX 10 support Open source compiler
	CUDA™ Parallel Processor Cores	16
	Power consumption	33.91 Watts
ATI FirePro V3700 256MB Graphics Card	Form Factor Graphics Controller Bus Type Memory	4.40 inches (H) × 6.70 inches (L) (11.18 cm (H) × 17.02 cm (L)) ATI FirePro V3700 Graphics Board PCI Express x16, Generation 2.0 256 MB GDDR3 SDRAM unified graphics memory
	Connectors	2 Dual Link DVI-I Two DVI-I to VGA adapters included
	Maximum Resolution	Two dual-link DVI-I outputs drive two digital displays at resolutions up to 2560 x 1600 @ 60Hz or two analog displays at resolutions up to 2048 x 1536 @ 85Hz
	Shading architecture	Full Shader Model 4.0
		 40 Stream Processing Units Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders Common instruction set and texture unit access supported for all types of shaders Dedicated branch execution units and texture address processors



Technical Specifications - Graphics			
	Supported graphics APIs Available graphics drivers	OpenGL 2.1 DirectX 10.1 Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)	
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html	
	Power consumption	Linux drivers may be obtained from: http://ati.amd.com/support/driver.html 32 Watts	
NVIDIA Quadro FX 580 512MB Graphics Card	Form Factor Graphics Controller	4.376 inches (H) × 6.60 inches (L) NVIDIA Quadro FX 580 Graphics Board	
	Bus Type	PCI Express x16, Generation 2.0	
	Memory	512MB GDDR3 SDRAM unified graphics memory	
	Connectors	2 DisplayPort, 1 Dual-Link DVI-I. One DisplayPort to DVI and one DVI to VGA adapter included	
		('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory)	
	Maximum Resolution	 Two DisplayPort outputs drive two digital displays up to 2560 x 1600 	
		 One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to 2048 x 1536 @ 85Hz 	
	RAMDAC	Single Internal 400 MHz DAC	
	Shading architecture	Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)	
		 Long fragment programs (unlimited instructions) Long vertex programs (unlimited instructions) Looping and subroutines (up to 256 loops per vertex program) Dynamic flow control Conditional execution 	
	Supported graphics APIs	OpenGL 3.0 Direct X 10.0	
	Available graphics drivers	Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation	
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html	
		Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com	
	High-level Shader Languages	 Optimized compiler for Cg and Microsoft HLSL OpenGL 2.1 and DirectX 10 support Open source compiler 	
	CUDA™ Parallel Processor Cores	32	
	Power consumption	40 Watts	



Technical Specifications - Graphics

RAMD	num Resolution DAC ing Architecture	 ('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory) Two DisplayPort outputs drive two digital displays up to 2560 x 1600 One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to 2048 x 1536 @ 85Hz Single Internal 400 MHz DAC
		Single Internal 400 MHz DAC
		-
		Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)
Supp	orted Graphics	 Long fragment programs (unlimited instructions) Long vertex programs (unlimited instructions) Looping and subroutines (up to 256 loops per vertex program) Dynamic flow control Conditional execution OpenGL 3.0
APIs	-	Direct X 10.0
Availa Driver	able Graphics rs	Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
		Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
	level Shader uages	 Optimized compiler for Cg and Microsoft HLSL OpenGL 2.1 and DirectX 10 support Open source compiler
	A™ Parallel essor Cores	64.
Powe	r consumption	59 Watts



Technical Specifica	tions - Graphics			
ATI FirePro V5700	Form Factor	4.40 inches (H) × 6.70 inches (L) (11.18 cm (H) × 17.02 cm (L))		
512MB Graphics Card	Graphics Controller	ATI FirePro V5700 Graphics Board		
	Bus Type	PCI Express x16, Generation 2.0		
	Memory	512 MB GDDR3 SDRAM unified graphics memory		
	Connectors	2 DisplayPort, 1 Dual-Link DVI-I. One DisplayPort to DVI and one DVI to VGA adapter included ('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory)		
	Maximum Resolution	 Two DisplayPort outputs drive two digital displays up to 2560 x 1600 One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up 		
		to 2048 x 1536 @ 85Hz		
	Shading architecture	Full Shader Model 4.0		
		 320 Stream Processing Units Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders Common instruction set and texture unit access supported for all types of shaders Dedicated branch execution units and texture address processors 		
	Supported graphics APIs	OpenGL 2.1 DirectX 10.1		
	Available graphics drivers	Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)		
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html		
		Linux drivers may be obtained from: http://ati.amd.com/support/driver.html		
	Power consumption	56 Watts		
NVIDIA Quadro FX 3800 1.0GB Graphics	Form Factor	4.376 inches (H) x 9.0 inches (L) Single slot card		
Card (NOT AVAILABLE	Graphics Controller	NVIDIA Quadro FX 3800 Graphics Board		
UNTIL JUNE 2009)	Bus Type	PCI Express x16, Generation 2.0		
	Memory	1GB GDDR3 SDRAM unified graphics memory		
	Connectors	2 DisplayPort, 1 Dual-Link DVI-I. One DisplayPort to DVI-D and one DVI to VGA adapter included		
		('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory)		
	Maximum Resolution	 Two DisplayPort outputs drive two digital displays up to 2560 x 1600 One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to 2048 x 1526 @ 8544 		
	RAMDAC	to 2048 x 1536 @ 85Hz Single Internal 400 MHz DAC		
	Shading architecture	Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)		
• / • •	-	 Long fragment programs (unlimited instructions) Long vertex programs (unlimited instructions) 		



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Technical Specifica	ations - Graphics			
		 Looping and subroutines (up to 256 loops per vertex program) Dynamic flow control Conditional execution 		
	Supported graphics APIs	OpenGL 3.0 Direct X 10.0		
	Available graphics drivers	Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation		
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html		
		Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com		
	High-level Shader Languages	 Optimized compiler for Cg and Microsoft HLSL OpenGL 2.1 and DirectX 10 support Open source compiler 		
	CUDA™ Parallel Processor Cores	192		
	Power consumption	107.9 Watts		
ATI FirePro V7750	Form Factor	4.40 inches (H) × 13.0 inches (L) (11.18 cm (H) × 33.02 cm (L))		
1.0GB Graphics Card	Graphics Controller	ATI FirePro V7750 Graphics Board		
	Bus Type	PCI Express x16, Generation 2.0		
	Memory	1024 MB GDDR3 SDRAM unified graphics memory		
	Connectors	2 DisplayPort, 1 Dual-Link DVI-I. One DisplayPort to DVI and one DVI to VGA adapter included ('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory)		
	Maximum Resolution	 Two DisplayPort outputs drive two digital displays up to 2560 x 1600 		
		 One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to 2048 x 1536 @ 85Hz 		
	Shading architecture	Full Shader Model 4.0		
		 320 Stream Processing Units Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders Common instruction set and texture unit access supported for all types of shaders Dedicated branch execution units and texture address processors 		
	Supported graphics APIs	OpenGL 2.1 DirectX 10.1		
	Available graphics drivers	Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)		
		HP qualified drivers may be preloaded or available from the HP support Web site:		
		http://welcome.hp.com/country/us/en/support.html		
		Linux drivers may be obtained from: http://ati.amd.com/support/driver.html		



Technical Specifications - Graphics

	Power consumption	76 Watts
NVIDIA Quadro FX 4800 1.5GB PCIe	Form Factor	4.36" (H) x 10.5" (L) Dual slot card
Graphics Card	Graphics Controller	NVIDIA Quadro FX 4800 graphics board
	Bus Type	PCI Express x16, Generation 2.0
	Memory	1.5 GB GDDR3 SDRAM unified graphics memory
	Connectors	2 DisplayPort, 1 Dual-Link DVI-I, 1 3-pin Mini DIN stereo output, Two DisplayPort to DVI-D adapters included ('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory)
	Maximum Resolution	 2 DisplayPort connectors support ultra-high-resolution panels (up to 2560 x 1600) Dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz Internal 400 MHz DACs-One analog display up to 2048 x 1536 @ 85Hz
	Shading Architecture	 Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class) Long fragment programs (unlimited instructions) Long vertex programs (unlimited instructions) Looping and subroutines (up to 256 loops per vertex program) Dynamic flow control Conditional execution
	Supported Graphics APIs	OpenGL 3.0 Direct X 10.0
	Available Graphics Drivers	Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation
		HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
		Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com
	High-Resolution AntiAliasing	 Rotated Grid Full-Scene Antialiasing (RG FSAA) 32xFSAA dramatically reduces visual aliasing artifacts or "jaggies" at resolution up to 1920 x 1200 64x FSAA SLI Mode
	High-level Shader Languages	 Optimized compiler for Cg and Microsoft HLSL OpenGL 2.1 and DirectX 10 support Open source compiler
	CUDA™ Parallel Processor Cores	192
	Power consumption	146 Watts



Technical Specifications - Graphics NVIDIA Quadro CX Form Factor 4.36" (H) x 10.5" (L) Dual slot card **Graphics Controller** NVIDIA Quadro CX 1.5GB Graphics Card **Bus Type** PCI Express x16, Generation 2.0 Memory 1.5 GB GDDR3 SDRAM unified graphics memory 2 DisplayPort, 1 Dual-Link DVI-I, 1 3-pin Mini DIN stereo output. Connectors Two DisplayPort to DVI-D adapters included ('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory) • 2 DisplayPort connectors support ultra-high-resolution panels (up **Maximum Resolution** to 2560 x 1600) • Dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz Internal 400 MHz DACs-One analog display up to 2048 x 1536 @ • 85Hz 400MHz RAMDAC Shading Architecture Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class) • Long fragment programs (unlimited instructions) • Long vertex programs (unlimited instructions) Looping and subroutines (up to 256 loops per vertex program) • Dynamic flow control Conditional execution OpenGL 3.0 **Supported Graphics APIs** Direct X 10.0 **Available Graphics** Genuine Windows Vista Business (64-bit and 32-bit) **Drivers** Microsoft Windows XP Professional (64-bit and 32-bit) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html **High-Resolution** • Rotated Grid Full-Scene Antialiasing (RG FSAA) AntiAliasing 32xFSAA dramatically reduces visual aliasing artifacts or "jaggies" • at resolution up to 1920 x 1200 • 64x FSAA SLI Mode Optimized compiler for Cg and Microsoft HLSL **High-level Shader** Languages OpenGL 2.1 and DirectX 10 support Open source compiler CUDA[™] Parallel 192 **Processor Cores**



146 Watts

Power consumption

Technical Specifications - Multimedia and Audio Devices

Integrated Intel/Realte	еkТуре	Integrated
HD ALC262 Audio	High Definition Codec	Yes
	FM Synthesis Support	Yes
	OPL3 FM Synthesis Support	Yes
	Sound Blaster Compatibility	Yes
	Meets Premium performance for Windows Logo Program 3.0	Yes
	Audio Jacks	Front panel microphone in and headphone out - fixed usage. Rear panel line in and line out jacks - jacks are retaskable One Line-In* (12-K ohm Input Impedance)* NOTE: External Speakers need to be powered externally.
	Sampling	3 stereo ADCs support 16/20-bit PCM format with 44.1K/48K/96kHz sample rate 2 stereo DAC supports 16/20/24-bit PCM format with 44.1K/48K/96K/192kHz sample rate
	Wavetable Syntheses (software)	Yes – GM and FM Midi Support, Direct Music and Down Loadable Soundset (4 Meg DLS Level 1 and 2 Support)
	3D Positional Sound	No
	Digital Audio	Yes
	Analog Audio	Yes
	DVD Audio	Yes
	Number of Channels on Line-Out	Stereo (Left & Right channels)
	Internal Audio Speake Power Rating	r 1.5 W
	Internal Speaker	Yes
	Hardware Equalizer fo Internal Speaker	r No
	External Speaker Jack (Line-Out)	x Yes



Technical Specifications - Multimedia and Audio Devices

HP Thin USB Powered Speakers	Frequency Response (- 3dB, 24-bit/96kHz input)	FO to 20kHz		
	Dimensions	Speakers: 5.72 x 3.74 x	0.96 in (14.52 x 9.50 x 2.45 cm) per speaker	
	On/Off/Volume Controls	Right side of right speaker		
	Power LED	Front of right speaker (green)		
	Watts	2/3 watt (normal/maximu	ım)	
	Net weight	0.68 lbs (0.31kg)		
	Environmental (all conditions non-	Temperature (operating):	14° to 104° F (-10° to 40° C)	
	condensing)	Relative Humidity (operating):	40% to 90%	
	Speaker cable length	Input cord: 5.91 ft (1800mm±35mm) L-channel cord: 3.28 ft (1000mm±35mm) USB cord: 5.91 ft (1800mm±35mm)		
	Color	HP Carbonite		
	Kit Contents	One pair of HP Thin USB Powered Speakers with attached audio signal and USB power cables for connecting to your PC HP Warranty documentation		

SoundBlaster (Creative 24-bit Analog-to-Digital 96kHz sample rateLabs) X-Fi Titaniumconversion of analog

PCle Audio Card

i Titanium lio Card	conversion of analog inputs	
	24-bit Digital-to-Analog conversion of digital sources	96kHz to analog 7:1 speaker output
	24-bit Digital-to-Analog conversion of stereo digital sources	8, 11.025, 16, 22.05, 24, 32, 44.1, 48 and 96kHz
	16-bit to 24-bit recording sampling rates	16-bit/44.1kHz, 16-bit/48kHz, 24-bit/44.1kHz, 24-bit/48kHz and 24- bit/96kHz with direct monitoring
	Enhanced SoundFont support	Up to 24-bit resolution
	Signal-to-Noise Ratio (2okHz Low-pass filter, A-Weighted)	109dB
	Total Harmonic Distortion + Noise at 1kHz (20kHz Low-pass filter)	.004%
	Frequency Response (- 3dB, 24-bit/96kHz input)	10Hz to 46kHz
	Frequency Response (- 3dB, 24-bit/192kHz input)	10Hz to 46kHz
	Speaker and Headphone connections	Stereo to 7.1 (Line Out via three 3.5mm mini jacks)
	Flexijack Front Panel Header	Line In/ Microphone In/Optical Out via shared 3.5mm mini jack Intel HD Audio Compatible (2x5 pin)



Technical Specifications - Multimedia and Audio Devices

Operating System	Microsoft Windows Vista Business 64 Microsoft Windows Vista Business 32 Microsoft® Windows® XP Professional SP2 Microsoft Windows XP Professional x64 Edition		
Minimum System	System RAM	512MB	
Requirements	Operating System	Windows Vista 32-bit and 64-bit version or Windows XP 32-bit or 64-bit version	



Technical Specifications - Optical and Removable Storage

NOTE 1: Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

HP DVD-ROM Drive	Description	5.25-inch, half-height, tra	ay-load	
	Mounting Orientation	Either horizontal or vertical		
	Interface Type	SATA/ATAPI		
	Dimensions (WxHxD)	5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)		
	Disc Capacity	DVD-ROM	Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB	
	Access Times	DVD-ROM Single Laye	r < 140 ms (typical)	
		CD-ROM Mode 1	< 125 ms (typical)	
		Full Stroke DVD	< 250 ms (seek)	
		Full Stroke CD	< 210 ms (seek)	
	Power	Source	SATA DC power receptacle	
		DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p	
		DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum 12 VDC - < 600 mA typical, < 1400 mA maximum	
	Operating	Temperature	41° to 122° F (5° to 50° C)	
	Environmental (all	Relative Humidity	10% to 90%	
	conditions non- condensing)	Maximum Wet Bulb Temperature	86° F (30° C)	
		Operating Systems Supported	Windows Vista Business 64* Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS3, WS4, 5 Desktop/Workstation Novell SLES 9 & SLE 10 No driver is required for this device. Native support is provided by the operating system.	
			* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/ upgradeadvisor. For Windows Vista system requirements, visit: http://www.windowsvista.com/ systemrequirements.	

 HP DVD+/-RW Drive
 Description
 5.25-inch, half-height, tray-load

 Mounting Orientation
 Either horizontal or vertical

 Interface Type
 SATA/ATAPI

 Dimensions (WxHxD)
 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)



Technical Specifications - Optical and Removable Storage

	Removable Clorage	•		
Disc Formats	DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW			
Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB sta	ndard	
	Full Stroke DVD	< 250 ms (seek)		
	Full Stroke CD	< 210 ms (seek)		
Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 40 CD-RW Up to 32X	X	
	DVD ROM Read	DVD-RAM	Up to 12X	
		DVD+RW	Up to 8X	
		DVD-RW	Up to 8X	
		DVD+R DL	Up to 8X	
		DVD-R DL	Up to 8X	
		DVD-ROM	Up to 16X	
		DVD-ROM DL	Up to 8X	
		DVD+R	Up to 16X	
		DVD-R	Up to 16X	
Power	Source	SATA DC power recepta	cle	
	DC Power Requirements	5 VDC ± 5%-100 mV rip 12 VDC ± 5%-200 mV rip		
	DC Current	5 VDC -1000 mA typical 12 VDC -600 mA typical		
Operating	Temperature	41° to 122° F (5° to 50° (C)	
Environmental (all	Relative Humidity	10% to 90%		
conditions non- condensing)	Maximum Wet Bulb Temperature	86° F (30° C)		
	Operating Systems Supported	Windows Vista Business Business 32*, Windows Windows 2000, Windows Windows XP Home 32*. Red Hat Enterprise Linu Desktop/Workstation Novell SLES 9 & SLE 10 No driver is required for t support is provided by th	Vista Home Basic 32*, s XP Professional or x(RHEL) WS3, WS4, 5) his device. Native	
		* Certain Windows Vista require advanced or addi Windows Vista Upgrade determine which feature: run on your computer. To visit: http://www.windowsvista For Windows Vista syste http://www.windowsvista systemrequirements.	Advisor can help you s of Windows Vista will o download the tool, .com/upgradeadvisor. em requirements, visit:	



Technical Specific	ations - Optical and F	Removable Storage		
		Kit Contents	* LightScribe functionality is not natively supported by Linux distributions. Customers may download LightScribe Linux drivers from: http://www.lightscribe.com/ downloadSection/linux/index.aspx HP SATA SuperMulti LightScribe DVD Writer drive, LightScribe software, Roxio Easy Media Creator software, Intervideo WinDVD Software, installation guide, and DVD+R media.	
HP Blu-Ray Writer	Description Mounting Orientation Interface Type Dimensions (WxHxD)	5.25-inch, half-height, tray-load Either horizontal or vertical SATA 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)		
	Disc Formats	BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW		
	Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB	standard
		Blu-ray	50 GB DL or 25 GB	
		Full Stroke DVD	< 250 ms (seek)	
		Full Stroke CD	< 210 ms (seek)	
		Blu-ray	Blu-ray	
		Startup Time (Time to		25S / 28S
		drive ready from tray	BD-R (SL/DL)	25S / 28S
		loading)	BD-RE (SL/DL)	25S / 28S
			DVD-ROM (SL/DL)	18S / 18S
			DVD-R (SL/DL)	25S / 25S
			DVD-RW	25S
			DVD+R (SL/DL)	25S / 25S
			DVD+RW	25S
			DVD-RAM	45S
			CD-ROM	45S
	Maximum Data	CD ROM Read	CD-ROM	Up to 40X
	Transfer Rates		CD-R	Up to 40X
			CD-RW	Up to 40X
		DVD ROM Read	DVD-RAM	Up to 5X
			DVD+RW	Up to 10X
			DVD-RW	Up to 10X
			DVD+R DL	Up to 8X
			DVD-R DL	Up to 8X
			DVD-ROM	Up to 16X



Technical Specifications - Optical and Removable Storage

	Blu-Ray	DVD-ROM DL DVD+R DVD-R BD-ROM BD-ROM DL	Up to 8X Up to 12X Up to 12X Up to 6X Up to 4.8X
		BD-R	Up to 6X
		BD-R DL	Up to 4.8X
		BD-R	Up to 6X
Power	Source	BD-RE SL/DL SATA DC power rece	Up to 4.8X
i owei	DC Power Requirements	5 VDC ± 5%-100 mV 12 VDC ± 10%-100 n	ripple p-p
	DC Current		cal, 1200 mA maximum pical, 1600 mA maximum
Operating	Temperature	41° to 122° F (5° to 50° C)	
Environmental (all conditions non-	Relative Humidity	15% to 80%	
condensing)	Maximum Wet Bulb Temperature	86° F (30° C)	
	Operating Systems Supported	Business 32*, Windo 32*, Windows 2000, Professional or Wind	ows XP Home 32*. .inux(RHEL) WS3, WS4, on
		support is provided b	for this device. Native by the operating system.
	Kit Contents	HP Blue Laser RW D software, Roxio Easy Intervideo WinDVD S guide.	Media Creator software,
Disclaimer	As Blu-Ray is a new for digital connection, comp and do not constitute de systems is not guarante may require a DVI or HI require HDCP support. I workstation.	patibility and/or perform efects in the product. Fl eed. In order for some E DMI digital connection a	ance issues may arise, lawless playback on all Blu-Ray titles to play, they and your display may



Technical Specifications - Optical and Removable Storage

HP 22-in-1 Media Card Reader		The Media Card Reader device uses the same physical form factor and mounting as a Floppy Disk Drive. The device connects to a 2x5 two- channel USB header on the motherboard of the system. There is no USB controller card provided. Please see the Disc Formats section below for a list of flash memory card formats that are supported.
	Mounting Orientation	The Media Card Reader can be mounted in a dedicated Floppy Drive bay (if the chassis provides one) or in an appropriate Optical Bay adapter. It will operate in any orientation.
	Interface Type	USB 2.0 (one channel dedicated to the separate USB port; one channel dedicated to the flash memory card slots)
	Dimensions (WxHxD)	4.9 x 4.0 x 1.0 in (124.5 x 101.6 x 25.4 mm)
	Disc Formats	xD-Picture Micro SD Micro SDHC SD SDHC Mini SD Mini SDHC MultiMediaCard (MMC) Reduced Size MultiMediaCard (RS MMC) MultiMedia Card 4.2 (MMC Plus, including MMC Plus HC) Reduced Size MultiMedia Card 4.2 (MMC Mobile, including MMC Mobile HC) CompactFlash Card Type I CompactFlash Card Type I CompactFlash Card Type II MicroDrive Memory Stick (MS) MagicGate Memory Stick Duo Memory Stick Select Memory Stick PRO (MS PRO) Memory Stick PRO Duo (MS PRO Duo) Memory Stick PRO-HG Duo Two additional formats are usable with adapters (not supplied): MMC Micro Memory Stick Micro (M2)



Technical Specifications - Controller Cards

HP FireWire/IEEE	Data Transfer Rate	Burst Data Rate up to 400 Mbps
1394a PCI Card	Device Interface Protocol	IEEE-1394a
	Devices Supported	IEEE-1394 compliant devices
	Bus Type	PCI card with brackets for low profile and full height PCI slots.
	Certification Level	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024- 1998 STD, Taiwan BSMI CNS13438, Korea MIC
	Ports	Two IEEE 1394 6-Pin Connector (Rear)
	Internal Connectors	One 10-Pin (9 Contacts) Custom Connector
	System Requirements	Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. No driver is required for this device. Native support is provided by the operating system.
		* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit: http://www.windowsvista.com/systemrequirements.
		Pentium II 266 or above 128-MB RAM 1-GB Hard Drive CD-ROM drive Built-in sound system Available PCI slot
	Temperature - Operating	50° to 131° F (10° to 55° C)
	Temperature - Storage	-22° to 140° F (-30° to 60° C)
	Relative Humidity - Operating	20% to 80%
	Operating Systems Supported	Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*
		* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit: http://www.windowsvista.com/systemrequirements.



Technical Specifications - Controller Cards

HP IEEE 1394b FireWire PCIe Card	Data Transfer Rate	Supports up to 800 Mbps
	Devices Supported	IEEE-1394 compliant devices
	Bus Type	PCIe card full height PCIe slots
	Ports	Two IEEE-1394b bilingual 9-Pin Connector (Rear)
	Internal Connectors	One 10-Pin header Custom Connector
	System Requirements	Microsoft Windows XP Professional, Windows XP Home, Windows Vista. Not supported on Linux. Pentium® III or higher processor 128-MB RAM 1-GB Hard Drive CD-ROM drive Built in sound system Available PCI slot
	Temperature – Operating	50° to 131° F (10° to 55° C)
	Temperature – Storage –22° to 140° F (–30° to 60° C)	
	Relative Humidity – Operating	20% to 80%
	Compliances	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024- 1998 STD, Taiwan BSMI CNS13438, Korea MIC
	Operating Systems Supported	Microsoft Windows XP and Windows Vista



Technical Specifications - Networking and Communications

NOTE 1: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

initiabilidetare ib required.		
Integrated Broadcom	Connector	RJ45
5764 PCIe LOM Controller	Data Rates Supported	
Controller	Bus Architecture	PCIe X1
	Alerting	ASF 2.0
Broadcom (5761) NetXtreme Gigabit	Connector	RJ-45
	Controller	Broadcom 5761 PCI-Express LAN Controller
Ethernet Plus NIC	Memory	8 MB NVRAM serial Flash
	Data Rates Supported	10/100/1000 Mbps
	Compliance	IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x
	Bus Architecture	PCI-Express
	Data Path Width	Single Channel PCI-Express
	Data Transfer Mode	Bus Master DMA
	Hardware Certifications	FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI for Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed (E212044), European Union Notice (CE 0682)
	Power Requirement	1.8W @ 3.3V
	Boot ROM Support	Yes
	Network Transfer Mode	Full-duplex Half-duplex (not available for the 1000BASE-T transceiver)
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Operating Temperature 32° to 131°F (0° to 55° C)	
	Operating Humidity	131° F (55° C) with 5% to 95% non-condensing humidity
	Dimensions	2.75 in x 4.13 in (7 cm x 10.5 cm), low profile compatible
	Operating System Driver Support	Windows Vista 32-bit SP1, Windows Vista x64 SP1, Windows XP 32 bit professional, Windows XP x64 .
	Management Capabilities	ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility, ASF2.0, DASH 1.0 and DASH 1.1 profiles
	Kit Contents	Broadcom NetXtreme Gigabit Ethernet Plus NIC, Broadcom NetXtreme Gigabit Ethernet Plus NIC USB Cable Assembly, CD, drivers, quick install guide, product warranty statement



Technical Specifications - Networking and Communications

Intel Gigabit CT Desktop NIC	Connector	RJ-45
	Controller	Intel WG82574L Gigabit Ethernet Controller
	Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers
	Data Rates Supported	10/100/1000 Mbps
	Compliance	IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x flow control
	Bus Architecture	PCI-E 1.0a
	Data Path Width	X1, 250 MB/s, Bi-directional interface
	Data Transfer Mode	Bus-master DMA
	Hardware Certifications	FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for European Union
	Power Requirement	Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T
	Boot ROM Support	Yes
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Operating Temperature 32° to 131°F (0° to 55° C)	
	Operating Humidity	85% at 131° F (55° C)
	Dimensions	4.75 x 2.25 x 0.8 in (12.1 x 5.7 x 2.0 cm)
	Operating System Driver Support	Windows Vista Business 64, Windows Vista Business 32, Windows XP Professional, Windows XP x64. Red Hat Enterprise Linux 4, Red Hat Enterprise Linux 5.
	Management Capabilities	WOL , PXE, DMI, WFM 2.0
	Kit Contents	Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel PROset II NIC drivers, quick install guide, product warranty statement

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